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AMENDMENT TRANSMITTAL LETTER (Large Entity)				Docket No. SEC.898D	
Applicant(s): Woo-Chan JUNG et al.					
Application No. 10/673,937	Filing Date September 30, 2003	Examiner Ida M. Soward	Customer No. 20987	Group Art Unit 2822	Confirmation No. 1631
Invention: METHOD OF MANUFACTURING INSULATING LAYER AND SEMICONDUCTOR DEVICE INCLUDING INSULATING LAYER, AND SEMICONDUCTOR DEVICE FORMED THEREBY					
<div style="display: flex; justify-content: space-between; align-items: center;"> <div> <p style="text-align: center;"><u>COMMISSIONER FOR PATENTS:</u></p> <p>Transmitted herewith is an amendment in the above-identified application. The fee has been calculated and is transmitted as shown below.</p> </div> <div style="border: 1px solid black; border-radius: 50%; padding: 10px; text-align: center;"> <p>OFFICE OF APR 28 2005 PATENT & TRADEMARK OFFICE</p> </div> </div>					
CLAIMS AS AMENDED					
	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST # PREV. PAID FOR	NUMBER EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	7 -	20 =	0	x \$50.00	\$0.00
INDEP. CLAIMS	1 -	3 =	0	x \$200.00	\$0.00
Multiple Dependent Claims (check if applicable) <input type="checkbox"/>					\$0.00
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT					\$0.00
<p><input checked="" type="checkbox"/> No additional fee is required for amendment.</p> <p><input type="checkbox"/> Please charge Deposit Account No. _____ in the amount of _____</p> <p><input type="checkbox"/> A check in the amount of _____ to cover the filing fee is enclosed.</p> <p><input checked="" type="checkbox"/> The Director is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account 50-0238</p> <p style="margin-left: 20px;"><input checked="" type="checkbox"/> Any additional filing fees required under 37 C.F.R. 1.16.</p> <p style="margin-left: 20px;"><input checked="" type="checkbox"/> Any patent application processing fees under 37 CFR 1.17.</p> <p><input type="checkbox"/> Payment by credit card. Form PTO-2038.</p> <p>WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.</p> <div style="margin-top: 20px;"> <p style="text-align: center;">_____ <i>Signature</i></p> </div> <div style="text-align: right; margin-top: 10px;"> <p>Dated: April 28, 2005</p> </div>					
<p>LINUS Y. PARK Reg. No. 45,261 Volentine Francos & Whitt, P.L.L.C. One Freedom Square 11951 Freedom Drive, Suite 1260 Reston, VA 20190 Tel. No. 571-283-0720</p>			<p>I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on _____</p> <p style="text-align: center;">_____ (Date)</p> <p style="text-align: center;">_____ <i>Signature of Person Mailing Correspondence</i></p> <p style="text-align: center;">_____ <i>Typed or Printed Name of Person Mailing Correspondence</i></p>		
CC:					



Application No. 10/673,937
SEC.898D
Amendment dated April 28, 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of :
Woo-Chan Jung et al. : Group Art Unit: 2822
Application No.: 10/673,937 : Examiner: Soward, IDA M.
Filed: September 30, 2003 :

METHOD OF MANUFACTURING INSULATING LAYER AND
SEMICONDUCTOR DEVICE INCLUDING INSULATING LAYER, AND
SEMICONDUCTOR DEVICE FORMED THEREBY

**AMENDMENT AND REQUEST FOR
RECONSIDERATION**

U.S. Patent and Trademark Office
Customer Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In response to the Office Action dated February 25, 2005, the Applicants submit the following claim amendments, and remarks and arguments regarding the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

Remarks/Arguments begin on page 6 of this paper.